



# Product Change Notification

**Change Notification #:** 115443 - 00  
**Change Title:** Intel® Edison Breakout Board Kit,  
Intel® Edison Compute Module,  
Intel® Edison Kit for Arduino\*,  
PCN 115443-00, Product Marking,  
Marking Change  
**Date of Publication:** April 14, 2017

## Key Characteristics of the Change:

Product Marking

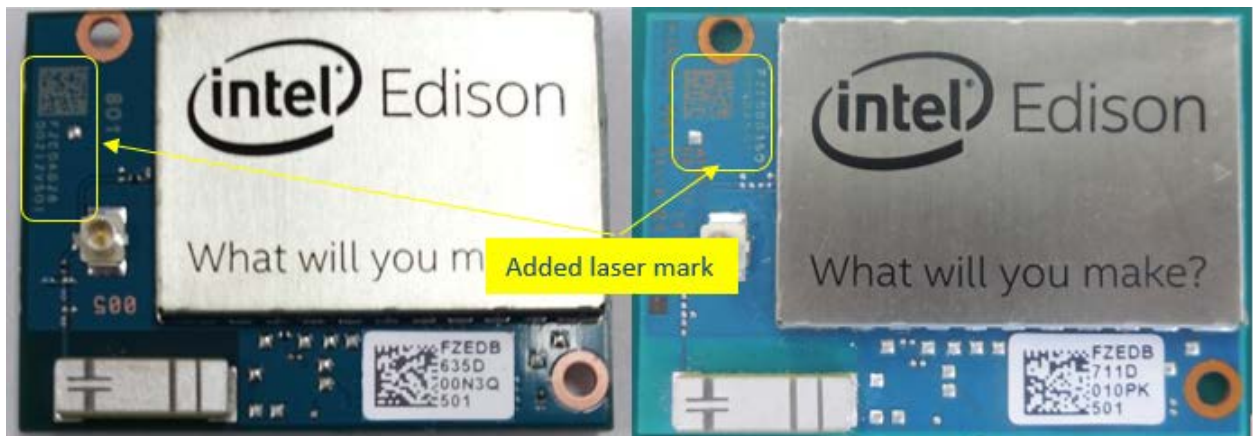
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Apr 21, 2017
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## Description of Change to the Customer:

The Intel® Edison SKUs listed in the products affected table will have the following change:

The manufacturing site will add a laser mark to PCBA on Edison to enable better process control and traceability.

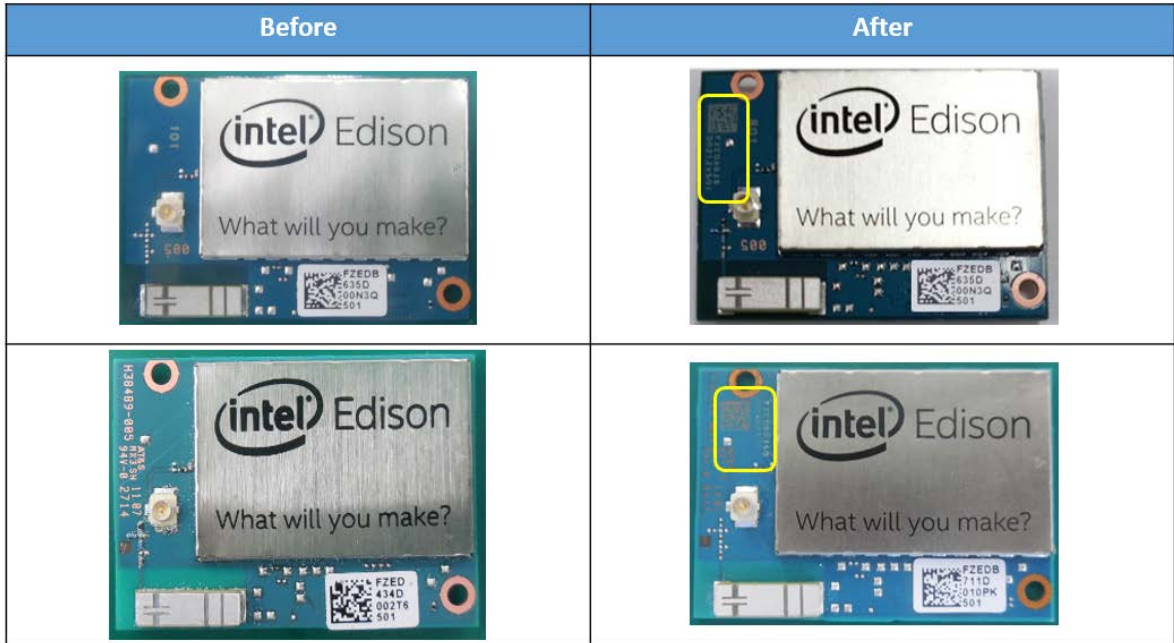


## Customer Impact of Change and Recommended Action:

Anticipate no impact to customers on form/fit/function. However the addition of the laser mark on the PCBA will be visible to customers. The intention of the PCN is to provide for informational purposes only. See below BEFORE & AFTER picture for reference.

There are no change to the Form, Fit, Function or ordering codes for these products.

## Before VS After



Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#
EDI2.SPON.AL.S	939910
EDI2.SPOF.AL.S	939957
EDI2.LPON.AL.S	939962
EDI2.LPOF.AL.S	939975
EDI2ARDUIN.AL.K	939976
EDI2BB.AL.K	939977
EDI2.SPON.AL.MP	939978
EDI2.SPOF.AL.MP	939983
EDI2.LPON.AL.MP	939985
EDI2.LPOF.AL.MP	939988
EDI3ARDUIN.AL.K	939997
EDI3BB.AL.K	939998

## PCN Revision History:

**Date of Revision:**

April 14, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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